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Features

Configuration

representative.

Mechanical Data

Package: SO-8 (Type TH)

STD-202, Method 208 @3)

Weight: 0.075 grams (Approximate)

DGD2184M

600V HALF BRIDGE GATE DRIVER IN SO-8

Floating High-Side Driver in Bootstrap Operation to 600V Drives Two N-Channel MOSFETs or IGBTs in Half Bridge

Wide Low-Side Gate Driver and Logic Supply: 10V to 20V

Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)

capable, and manufactured in IATF 16949 certified facilities), please contact us or your local Diodes

Package Material: Molded Plastic. "Green" Molding Compound.

Terminals: Finish - Matte Tin Plated Leads, Solderable per MIL-

SO-8

Top View

Halogen and Antimony Free. "Green" Device (Note 3) For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/104/200, PPAP

https://www.diodes.com/quality/product-definitions/

UL Flammability Classification Rating 94V-0 Moisture Sensitivity: Level 3 per J-STD-020

Schmitt Triggered Logic Inputs with Internal Pull Down

Undervoltage Lockout for High- and Low-Side Drivers Extended Temperature Range: -40°C to +125°C

1.9A Source / 2.3A Sink Output Current Capability

Internal Dead Time of 395ns to Protect MOSFETs

Outputs Tolerant to Negative Transients

Logic Input (IN and SD*) 3.3V Capability

Description

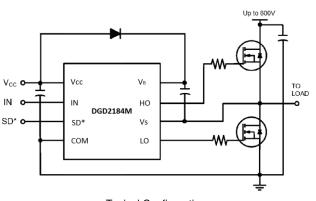
The DGD2184M is a high-voltage and high-speed gate driver capable of driving N-Channel MOSFETs and IGBTs in a half bridge configuration. High-voltage processing techniques enable the DGD2184M's high-side to switch to 600V in a bootstrap operation.

The DGD2184M logic inputs are compatible with standard TTL and CMOS levels (down to 3.3V) for easy interfacing with controlling devices. The driver outputs feature high-pulse current buffers designed for minimum driver cross conduction. The DGD2184M has a fixed internal deadtime of 395ns (typ).

The DGD2184M is offered in the SO-8 (Type TH) package, and the operating temperature extends from -40°C to +125°C.

Applications

- DC-DC converters
- DC-AC inverters
- AC-DC power supplies
- Motor controls
- Class D power amplifiers



Typical Configuration

Ordering Information (Note 4)

Orderable Part Number	Pookogo	Marking	Reel Size (inch)	Tape Width (mm)	Packing	
Orderable Part Number	Package			rape width (mm)	Qty.	Carrier
DGD2184MS8-13	SO-8 (Type TH)	DGD2184M	13	12	2,500	Reel

Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information

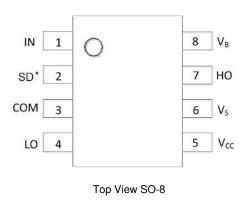


)¦¦ = Manufacturer's Marking DGD2184M = Product Type Marking Code YY = Year (ex: 23 = 2023) WW = Week (01 to 53)





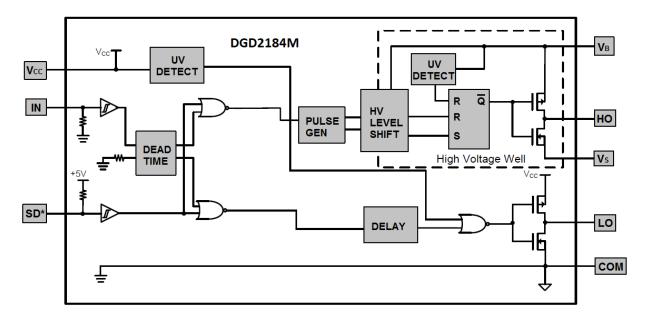
Pin Diagrams



Pin Descriptions

Pin Number	Pin Name	Function
1	IN	Logic Input for High-Side and Low-Side Gate Driver Outputs (HO and LO), in Phase with HO
2	SD*	Logic Input for Shutdown, Enabled Low
3	COM	Low-Side and Logic Return
4	LO	Low-Side Gate Drive Output
5	Vcc	Low-Side and Logic Fixed Supply
6	Vs	High-Side Floating Supply Return
7	HO	High-Side Gate Drive Output
8	VB	High-Side Floating Supply

Functional Block Diagram





Absolute Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
High-Side Floating Supply Voltage	VB	-0.3 to +624	V
High-Side Floating Supply Offset Voltage	Vs	$V_{B} - 24$ to $V_{B} + 0.3$	V
High-Side Floating Output Voltage	V _{HO}	$V_{\rm S} - 0.3$ to $V_{\rm B} + 0.3$	V
Offset Supply Voltage Transient	dV _S / dt	50	V/ns
Low-Side Fixed Supply Voltage	V _{CC}	-0.3 to +24	V
Low-Side Output Voltage	V _{LO}	-0.3 to V _{CC} + 0.3	V
Logic Input Voltage (IN and SD*)	V _{IN}	-0.3 to V _{CC} + 0.3	V

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Power Dissipation Linear Derating Factor (Note 5)	PD	0.625	W
Thermal Resistance, Junction to Ambient (Note 5)	R _{0JA}	200	°C/W
Operating Temperature	TJ	+150	
Lead Temperature (Soldering, 10s)	TL	+300	°C
Storage Temperature Range	T _{STG}	-55 to +150	

Note: 5. When mounted on a standard JEDEC 2-layer FR-4 board.

Recommended Operating Conditions

Parameter	Symbol	Min	Max	Unit
High-Side Floating Supply Absolute Voltage	VB	Vs + 10	V _S + 20	V
High-Side Floating Supply Offset Voltage	Vs	(Note 6)	600	V
High-Side Floating Output Voltage	V _{HO}	Vs	VB	V
Low-Side Fixed Supply Voltage	V _{CC}	10	20	V
Low-Side Output Voltage	V _{LO}	0	Vcc	V
Logic Input Voltage (IN and SD*)	V _{IN}	0	V _{CC}	V
Ambient Temperature	TA	-40	+125	°C

Note: 6. Logic operation for V_S of -5V to +600V.



DC Electrical Characteristics (V_{BIAS} (V_{CC}, V_{BS}) = 15V, @T_A = +25°C, unless otherwise specified.) (Note 7)

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Parameter	Symbol	Min	Тур	Max	Unit	Conditions
Logic "1" Input Voltage	VIH	2.5		_	V	$V_{CC} = 10V$ to 20V
Logic "0" Input Voltage	V _{IL}		—	0.8	V	$V_{CC} = 10V$ to 20V
SD* Input Positive Going Threshold	V _{SDTH+}	2.5	—	-	V	$V_{CC} = 10V$ to 20V
SD* Input Negative Going Threshold	V _{SDTH-}		_	0.8	V	$V_{CC} = 10V$ to 20V
High Level Output Voltage, V _{BIAS} – V _O	V _{OH}		_	1.2	V	$I_0 = 0 m A$
Low Level Output Voltage, V _O	V _{OL}		—	0.1	V	$I_0 = 20 \text{mA}$
Offset Supply Leakage Current	I _{LK}		—	50	μA	$V_B = V_S = 600V$
Quiescent V _{BS} Supply Current	I _{BSQ}	20	60	150	μA	$V_{IN} = 0V \text{ or } 5V$
Quiescent V _{CC} Supply Current	I _{CCQ}	0.4	1.0	1.8	mA	$V_{IN} = 0V \text{ or } 5V$
Logic "1" Input Bias Current	I _{IN+}	_	25	60	μA	IN = 5V, SD* = 0V
Logic "0" Input Bias Current	I _{IN-}	—	—	1.0	μA	IN = 0V, SD* = 5V
V _{BS} Supply Under-Voltage Positive Going Threshold	V _{BSUV+}	8.0	8.9	9.8	V	—
V _{BS} Supply Under-Voltage Negative Going Threshold	V _{BSUV-}	7.4	8.2	9.0	V	—
V _{CC} Supply Under-Voltage Positive Going Threshold	V _{CCUV+}	8.0	8.9	9.8	V	—
V _{CC} Supply Under-Voltage Negative Going Threshold	V _{CCUV-}	7.4	8.2	9.0	V	—
Output High Short Circuit Pulsed Current	I _{O+}	1.4	1.9	_	Α	V _O = 0V, PW ≤ 10µs
Output Low Short Circuit Pulsed Current	Io-	1.7	2.3	—	А	V _O = 15V, PW ≤ 10µs

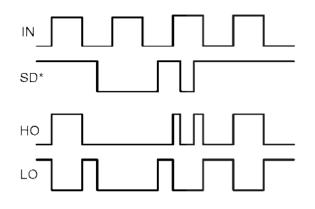
Note: 7. The V_{IN} and I_{IN} parameters are applicable to the two logic input pins: IN and SD*. The V_O and I_O parameters are applicable to the respective output pins: HO and LO.

AC Electrical Characteristics (V_{BLAS} (V_{CC} , V_{BS}) = 15V, C_L = 1000pF, @T_A = +25°C, unless otherwise specified.)

Parameter	Symbol	Min	Тур	Max	Unit	Conditions
Turn-On Propagation Delay	t _{on}	—	585	900	ns	$V_{\rm S} = 0V$
Turn-Off Propagation Delay	t _{off}	—	170	400	ns	$V_{\rm S} = 0V \text{ or } 600V$
Shut-Down Propagation Delay	t _{SD}	—	180	270	ns	—
Delay Matching, HO & LO Turn-On	t DMON	—	—	90	ns	—
Delay Matching, HO & LO Turn-Off	t _{DMOFF}	—	—	40	ns	$I_{O} = 0A$
Turn-On Rise Time	tr	—	40	60	ns	$V_{\rm S} = 0V$
Turn-Off Fall Time	t _f	—	20	35	ns	$V_{\rm S} = 0V$
Deadtime: t _{DT LO-HO &} t _{DT HO-LO}	t _{DT}	345	395	445	ns	—



Timing Waveforms





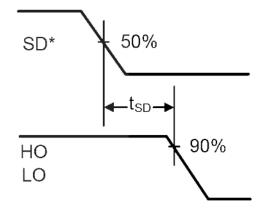
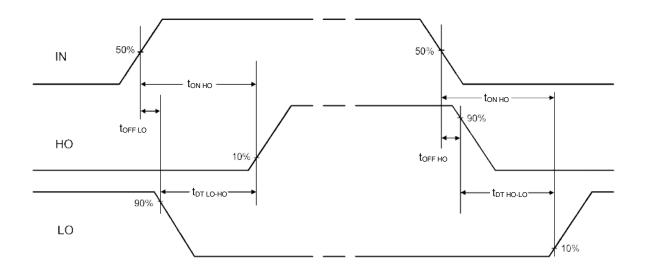


Figure 2. Shutdown Waveform Definitions



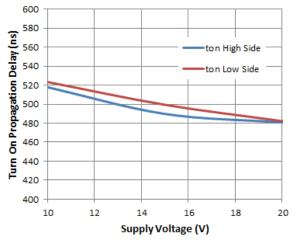
 $\begin{array}{l} \text{Deadtime } t_{\text{DT }\text{LO-HO}} = t_{\text{ON }\text{HO}} \text{ - } t_{\text{OFF }\text{LO}} \\ t_{\text{DT }\text{HO-LO}} = t_{\text{ON }\text{LO}} \text{ - } t_{\text{OFF }\text{HO}} \\ \text{Deadtime matching} \\ t_{\text{MDT}} = t_{\text{DT }\text{LO-HO}} \text{ - } t_{\text{DT }\text{HO-LO}} \end{array}$

Delay matching t_{DM OFF} = toff Lo - tofft но

Figure 3. Switching Time Waveform Definitions



Typical Performance Characteristics (@T_A = +25°C, V_{CC} = 15V, unless otherwise specified.)



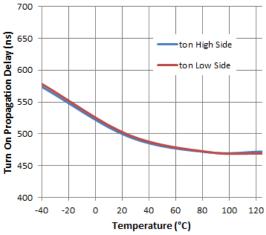


Figure 4. Turn-on Propagation Delay vs. Supply Voltage

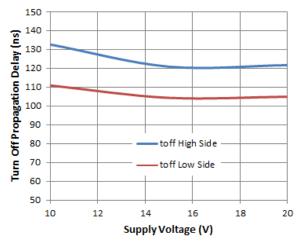


Figure 6. Turn-off Propagation Delay vs. Supply Voltage

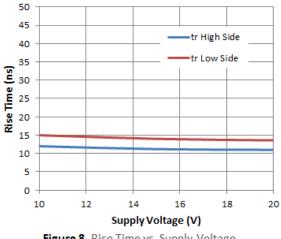


Figure 8. Rise Time vs. Supply Voltage

Figure 5. Turn-on Propagation Delay vs. Temperature

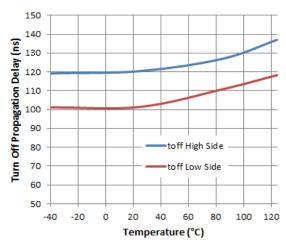


Figure 7. Turn-off Propagation Delay vs. Temperature

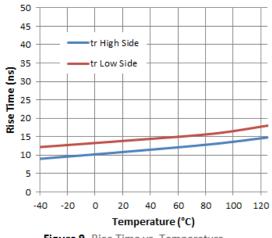
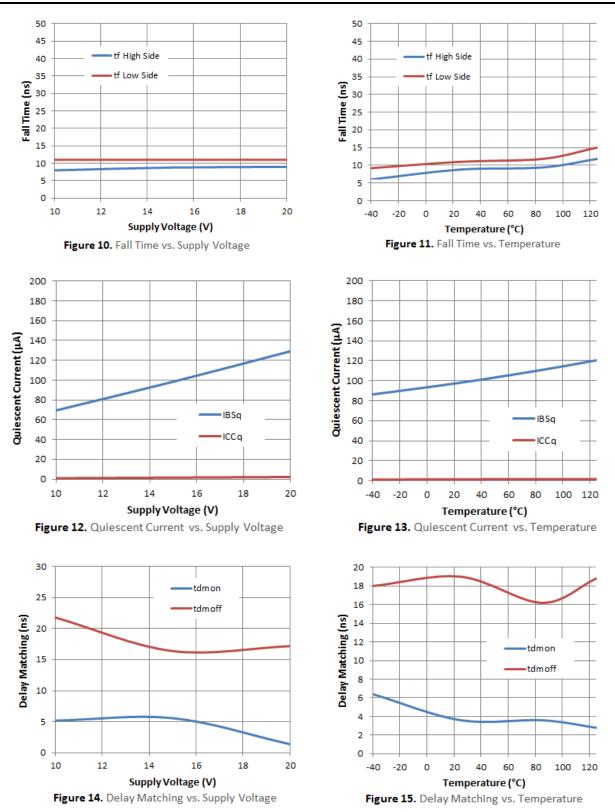
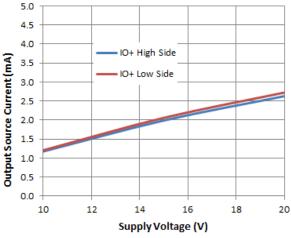


Figure 9. Rise Time vs. Temperature











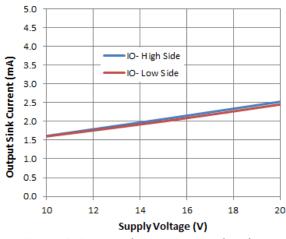


Figure 18. Output Sink Current vs. Supply Voltage

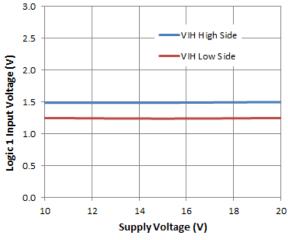
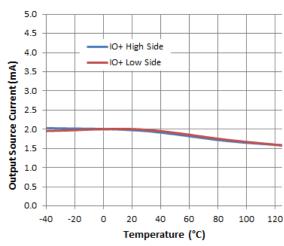


Figure 20. Logic 1 Input Voltage vs. Supply Voltage





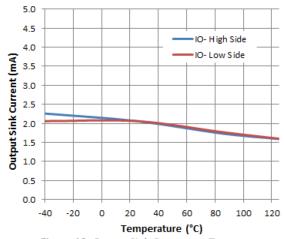


Figure 19. Output Sink Current vs. Temperature

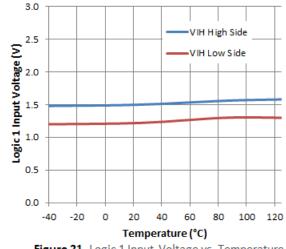
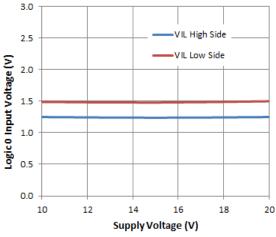
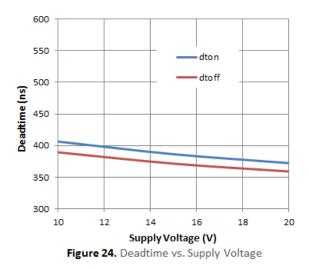


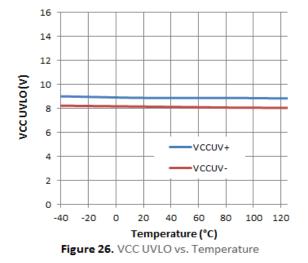
Figure 21. Logic 1 Input Voltage vs. Temperature











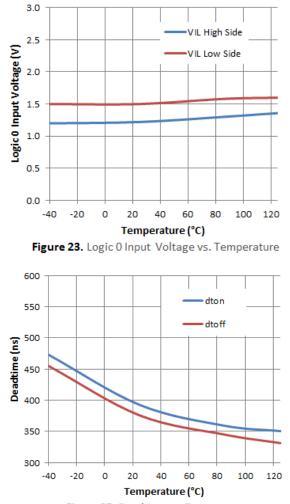
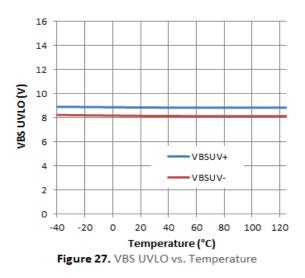


Figure 25. Deadtime vs. Temperature





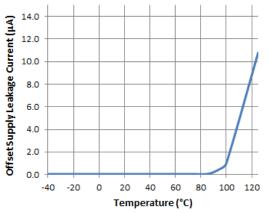
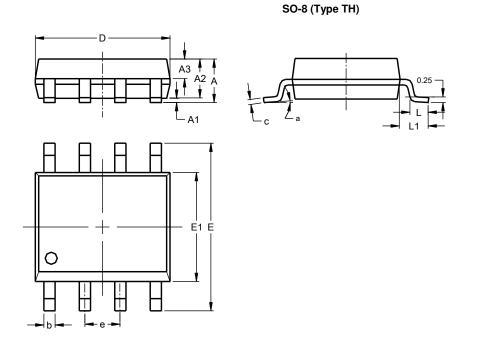


Figure 28. Offset Supply Leakage Current vs. Temperature



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

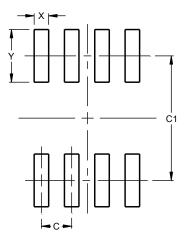


SO-8 (Type TH)						
Dim	Min	Тур				
Α	-	1.75				
A1	0.10	0.225				
A2	1.30	1.50	1.40			
A3	0.60	0.70	0.65			
b	0.39	0.47				
С	0.20	0.24				
D	4.80	5.00	4.90			
Е	5.80	6.20	6.00			
E1	3.80	4.00	3.90			
e	1	.27BSC	;			
h	0.25	0.50				
L	0.50	0.80				
L1	1.05REF					
а	0°	8°				
All Dimensions in mm						

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.





 Dimensions
 Value (in mm)

 C
 1.27

 C1
 5.20

 X
 0.60

 Y
 2.20



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